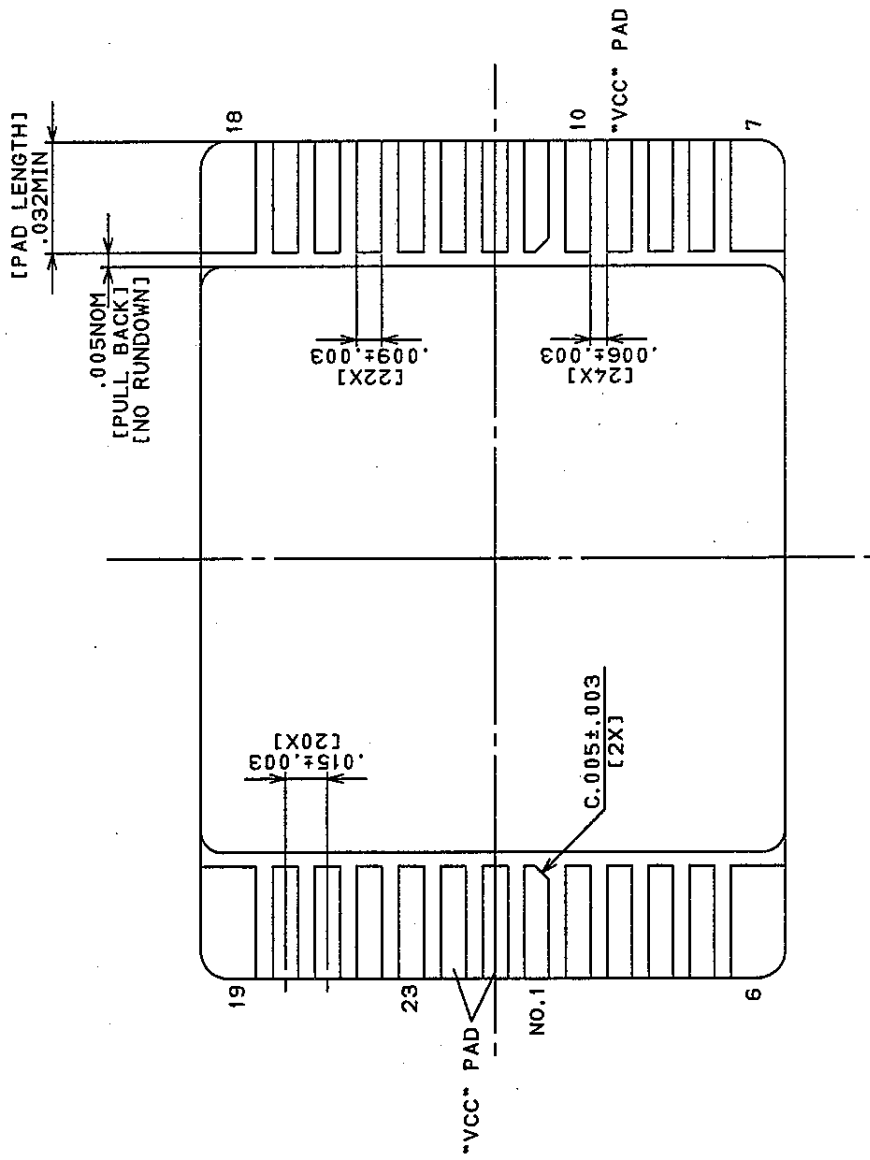


NOTES:

1. GOLD PLATE 100μ INCHES MIN OVER
 80μ INCHES MIN NICKEL.
2. SEAL RING ISOLATED.
3. NOTCH TO BE ELECTRICALLY
 CONNECTED TO THE DIE ATTACH.
4. "VCC" PAD TO BE ELECTRICALLY
 CONNECTED TO THE LEAD NO.24.
5. LEAD RESISTANCE : $500 \text{ m}\Omega$ MAX.



B/G PADS DETAIL